IN THE CLAIMS

Complete listing of the claims:

- 1. (Currently amended) A film forming system comprising:
 - a chamber,
 - a precursory gas supplying line to supply the chamber with precursory gas,
 - a reactive gas supplying line to supply the chamber with reactive gas, and
- a purge gas supplying line to supply purge gas that purges the precursory gas and the reactive gas, and that forms a thin film on a substrate in the chamber by supplying the precursory gas or the reactive gas and purging alternately, wherein further comprising and

a precursory gas middle line having a <u>certain predetermined</u> volume that is arranged on a part or all of the precursor supplying line and into which the precursory gas can be filled at a time when the precursory gas is not supplied, and/or a <u>reactive gas middle line having a certain</u> volume that is arranged on a part or all of the reactive gas supplying line and into which the reactive gas can be filled at a time when the reactive gas is not supplied,

wherein a switching valve is arranged on each of an inlet port and an outlet port of the precursory gas middle line and/or the reactive gas middle line respectively so as to specify a volume of the precursory gas middle line and/or the reactive gas middle line with the cross-sectional area of a line body constituting the precursory gas middle line and/or the reactive gas middle line and a distance between each of the switching valves.

- 2. (Cancelled)
- 3. (Currently amended) The film forming system described in claim 2 claim 1, wherein the switching valve is a three-way valve.
- 4. (Currently amended) The film forming system described in claim 1, wherein the purge gas supplying line is connected to the precursory gas supplying line to which the <u>precursory gas</u> middle line is arranged and/or the reactive gas supplying line to which the <u>reactive gas</u> middle line is arranged and the precursory gas and/or the reactive gas each of which is filled in the

Case No. KKP0002US Serial No. 10/585,267 precursory gas middle line and/or the reactive gas middle line is supplied to the chamber by

pushing out the precursory gas and/or the reactive gas by the use of the purge gas.

5. (Original) The film forming system described in claim 1, wherein the precursory gas and/or

the reactive gas is supplied to the chamber in 0.1 through 2 second.

6. (Currently amended) The film forming system described in claim 1, wherein a concentration

adjusting deviceconcentration adjusting devices to adjust each concentration of the precursory

gas and the reactive gas is connected to the precursory gas supplying line and the reactive gas

supplying line respectively and each concentration adjusting device adjusts each concentration

of the precursory gas and the reactive gas so as to supply each gas at more than or equal to

 0.15×10^{-6} mol/cm² with respect to an area of the substrate on which the thin film is formed.

7. (Original) The film forming system described in claim 1, wherein each of the precursory gas

supplying line and the reactive gas supplying line is independently connected to the chamber.

8. (Original) The film forming system described in claim 1, and that is arranged to purge the

chamber so that each concentration of the precursory gas and/or the reactive gas becomes less

than or equal to 1/1000 in less than or equal to 2 seconds.

9. (Cancelled)

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